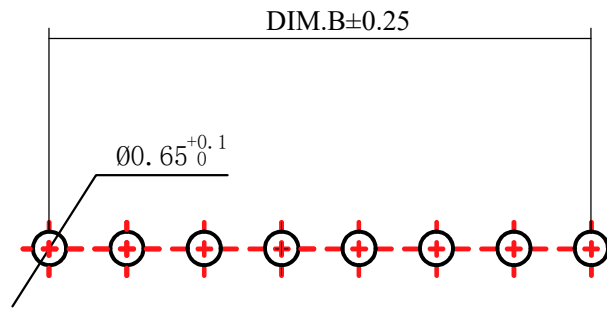
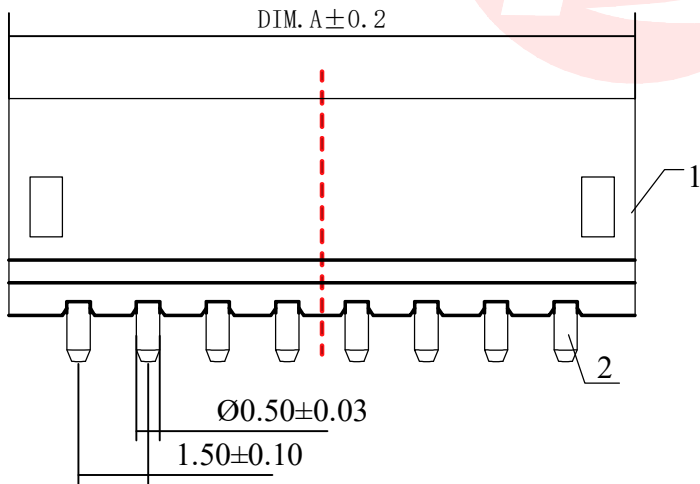
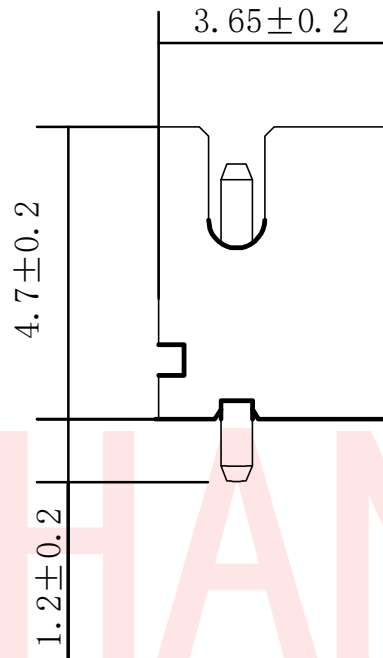
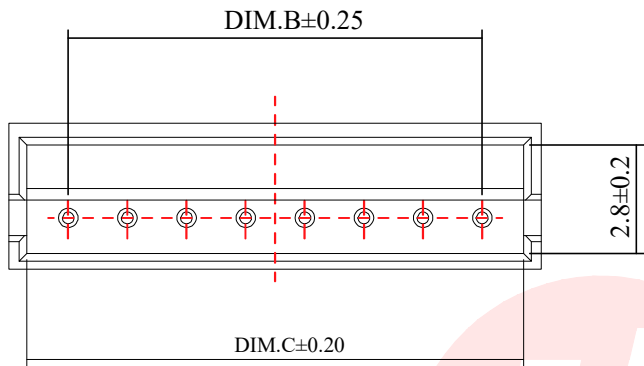




5	6		
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



PCB Layout

技术要求:

- 1) 材质:见附表;
- 2) 电镀:见附表;
- 3) 塑件表面平整、光洁、无毛刺、气泡、烧焦、变形、浇口无拉伤、多料或缺料等不良现象;
- 4) 端子表面无氧化、电镀不良等现象。

适应基板厚度: 1.2mm~1.6mm

温度范围: -25°C~85°C

额定电压: 250V AC/DC

额定电流: 1A

绝缘电阻: ≥1000MΩ

耐压: 800V AC/minute

TABLE:

CSG PART NO.	PIN位	A	B	C
WAFER-ZH150Z-Z122A	2PIN	4.50	1.50	3.60
WAFER-ZH150Z-Z123A	3PIN	6.00	3.00	5.10
WAFER-ZH150Z-Z124A	4PIN	7.50	4.50	6.60
WAFER-ZH150Z-Z125A	5PIN	9.00	6.00	8.10
WAFER-ZH150Z-Z126A	6PIN	10.50	7.50	9.60
WAFER-ZH150Z-Z127A	7PIN	12.00	9.00	11.10
WAFER-ZH150Z-Z128A	8PIN	13.50	10.50	12.60
WAFER-ZH150Z-Z129A	9PIN	15.00	12.00	14.10
WAFER-ZH150Z-Z1210A	10PIN	16.50	13.50	15.60
WAFER-ZH150Z-Z1211A	11PIN	18.00	15.00	17.10
WAFER-ZH150Z-Z1212A	12PIN	19.50	16.50	18.60

2	PIN	n PCS	材质:黄铜, 电镀: 镀亮锡60u~MIN
1	Housing	1 PCS	材质:6T, 颜色:本色
NO.	NAME	Q'TY	DESCRIPTION

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:
 X :±0.35 X :±2°
 X.X :±0.25 X.X :±1°
 X.XX :±0.15

东莞市汉博电子科技有限公司
 DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	WAFER ZH 1.50 短针1.2针长直针		
DWN	xiong	PART NO.WAFER-ZH150Z-Z12NA	
CHKD	lee	SCALE:1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET:10F 1 REV: A4

CUSTOMER COPY